3.3.3 Number of books and chapters in edited volumes/books published and papers published in national/ international conference

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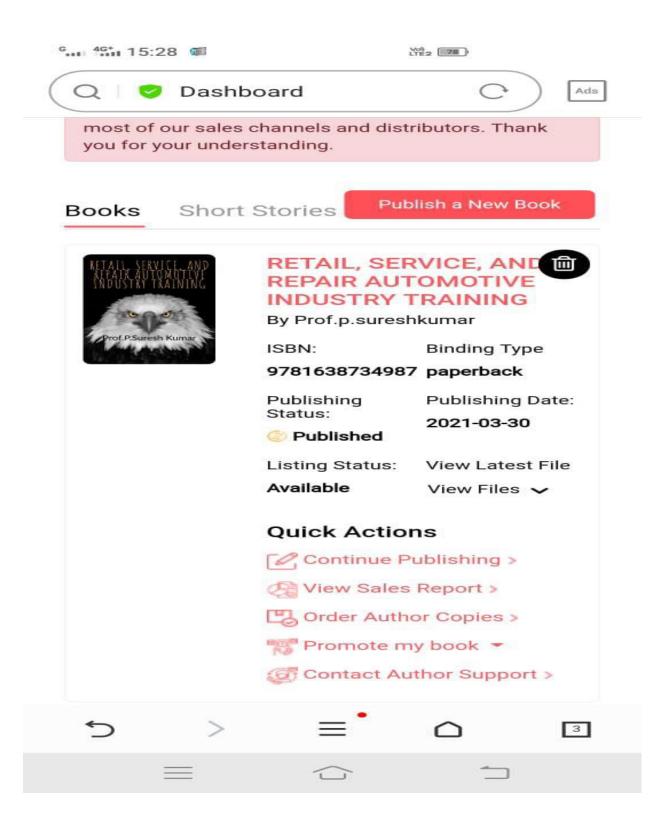
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In recent years, smart systems and control science are entering into a new technology phase. This initiative reflects new challenges and stimulates the need of rapid research awareness on realizing various smart systems and control strategies into existence. The 5th International Conference on Inventive Systems and Control [ICISC 2021] which is to be held on 7-8 January 2021 at JCT College of Engineering and Technology, Coimbatore, India will initiate an open forum for academicians. researchers and industrialists where the recent advances in control science and systems engineering can be extensively discussed, shared and examined. ICISC 2021 is solely dedicated to publish highquality and transferable innovations across all the aspects in the fields of inventive smart systems and control science with an extensive interest in the areas of formulation, implementation and analysis in the fields of control and information science.

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ADVANCES IN VLSI DESIGN AND ITS VARIOUS FABRICATION TECHNOLOGIES

Thahseen Thahir and D. Vedha Vinodha

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Abstract

Three-dimensional (3D) integration is an emerging technology that is expected to lead to an industry paradigm shift due to its tremendous benefits. In the advanced technology scaling, IC chips have remained essentially two-dimensional (2D). In contrast with conventional 2D circuits, 3D integrated circuits offer a new paradigm that builds multiple tiers of active devices stacked above each other. A 3D circuit is the stacking of regular 2D circuits. Three dimensional integration for possible alternatives that provide better or equal performance with lower cost. In this paper we will discuss the opportunities, and possible solutions for 3D integrated devices.

Recent advances in process technology have brought 3D technology to the point where it is feasible and practical, and it has raised widespread interest in the chip industry. Threedimensional (3D) integration is an emerging technology that can form highly integrated systems by vertically stacking and connecting various materials, technologies and functional components together. The potential benefits of 3D integration can vary depending on approach; they include multifunctionality, increased performance, reduced power, small form factor, reduced packaging, increased yield and reliability, flexible heterogeneous integration and reduced overall costs. For example, a small form factor is achieved by stacking active component layers on top of one another in any 3D approach.

One of several promising solutions being explored is the 3D integration and packaging technology (also known as vertical integration), in which multiple layers of active devices are stacked with vertical interconnections between the layers to form 3D integrated circuits (ICs). Even in the absence of continued device scaling, 3D ICs provide potential performance advances, since each transistor in a 3D IC can access a greater number of nearest neighbors, and each circuit functional block has higher bandwidth. Other benefits of 3D ICs include improved packing density, noise immunity, and improved total power due to reduced wire length/lower capacitance, superior. 3D technology enables the memory arrays to be placed above or under logic circuitry, resulting in an increased bandwidth. In particular, as the amount of on-chip memory increases,

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the latency of the path from logic to memory becomes a limiting factor in the logic-memory system. The ability to stack logic and memory has been demonstrated. In addition, one can determine system performance as a function of the number of device layers. Maximum performance depends on power dissipation constraints. Simple models of device and system dependencies have been developed, and optimizations have been performed. These layering models ignore the impact of blockage due to signals passing through a device layer.

Keywords: Three-dimensional integrated circuit (3D IC), 3D Integration, 3D